

Hardware User Manual

EXT-BF5xx-EXP-TR V1.x

...maximum performance at minimum space



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The information herein is given to describe certain components and shall not be considered as a guarantee of characteristics.

Terms of delivery and rights of technical change reserved.

We hereby disclaim any warranties, including but not limited to warranties of non-infringement, regarding circuits, descriptions and charts stated herein.

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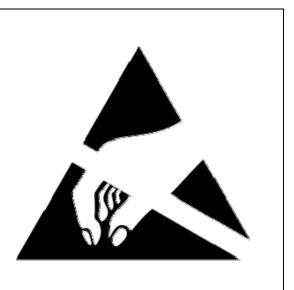
Information

For further information on technology, delivery terms and conditions and prices please contact Bluetechnix (http://www.bluetechnix.com).

Warning

Due to technical requirements components may contain dangerous substances.

The Core Modules and development systems contain ESD (electrostatic discharge) sensitive devices. Electro-static charges readily accumulate on the human body and equipment and can discharge without detection. Permanent damage may occur on devices subjected to high-energy discharges. Proper ESD precautions are recommended to avoid performance degradation or loss of functionality. Unused Core Modules and Development Boards should be stored in the protective shipping





BLACKFIN Products

Core Modules:

CM-BF533:	Blackfin Processor Module powered by Analog Devices' single core ADSP-BF533 processor; up to 600MHz, 32MB SDRAM, 2MB flash, 2x60 pin expansion connectors and a size of 36.5x31.5mm.
CM-BF537E:	Blackfin Processor Module powered by Analog Devices' single core ADSP-BF537 processor; up to 600MHz, 32MB SDRAM, 4MB flash, integrated TP10/100 Ethernet physical transceiver, 2x60 pin expansion connectors and a size of 36.5x31.5mm.
CM-BF537U:	Blackfin Processor Module powered by Analog Devices' single core ADSP-BF537 processor; up to 600MHz, 32MB SDRAM, 4MB flash, integrated USB 2.0 Device, 2x60 pin expansion connectors and a size of 36.5x31.5mm.
TCM-BF537:	Blackfin Processor Module powered by Analog Devices' single core ADSP-BF537 processor; up to 500MHz, 32MB SDRAM, 8MB flash, a size of 28x28mm, 2x60 pin expansion connectors, Ball Grid Array or Border Pads for reflow soldering, industrial temperature range -40°C to +85°C.
CM-BF561:	Blackfin Processor Module powered by Analog Devices' dual core ADSP-BF561 processor; up to 2x 600MHz, 64MB SDRAM, 8MB flash, 2x60 pin expansion connectors and a size of 36.5x31.5mm.
CM-BF527:	The new Blackfin Processor Module is powered by Analog Devices' single core ADSP-BF527 processor; key features are USB OTG 2.0 and Ethernet. The 2x60 pin expansion connectors are backwards compatible with other Core Modules.
CM-BF548:	The new Blackfin Processor Module is powered by Analog Devices' single core ADSP-BF548 processor; key features are 64MB DDR SD-RAM 2x100 pin expansion connectors.
TCM-BF518:	The new Core Module CM-BF518 is powered by Analog Devices' single core ADSP-BF518 processor; up to 400MHz, 32MB SDRAM, up to 8MB flash. The 2x60 pin expansion connectors are backwards compatible with other Core Modules.
Development Boards:	
EVAL-BF5xx:	Low cost Blackfin processor Evaluation Board with one socket for any Bluetechnix Blackfin Core Module. Additional interfaces are available, e.g. an SD-Card.
DEV-BF5xxDA-Lite:	Get ready to program and debug Bluetechnix Core Modules with this tiny development platform including an USB-Based Debug Agent. The DEV-BF5xxDA-Lite is a low cost starter development system including a VDSP++ Evaluation Software License.
DEV-BF548-Lite:	Low-cost development board with one socket for Bluetechnix CM-BF548 Core Module. Additional interfaces are available, e.g. an SD-Card, USB and Ethernet.



DEV-BF548DA-Lite:	Get ready to program and debug Bluetechnix CM-BF548 Core Module with this tiny development platform including an USB-Based Debug Agent. The DEV- BF548DA-Lite is a low-cost starter development system including a VDSP++ Evaluation Software License.
EXT-Boards:	The following Extender Boards are available: EXT-BF5xx-AUDIO, EXT-BF5xx- VIDEO, EXT-BF5xx-CAM, EXT-BF5xx-EXP-TR, EXT-BF5xx-USB-ETH2, EXT-BF5xx- AD/DA, EXT-BF548-EXP and EXT-BF518-ETH. Furthermore, we offer the development of customized extender boards for our customers.
Software Support:	
BLACKSheep:	The BLACKSheep VDK is a multithreaded framework for the Blackfin processor family from Analog Devices that includes driver support for a variety of hardware extensions. It is based on the real-time VDK kernel included within the VDSP++ development environment.
LabVIEW:	LabVIEW embedded support for Bluetechnix Core Modules is done by Schmid- Engineering AG: <u>http://www.schmid-engineering.ch</u>
uClinux:	All the Core Modules are fully supported by uClinux. The required boot loader

Upcoming Products and Software Releases:

Keep up-to-date with all the changes to the Bluetechnix product line and software updates at: <u>http://www.bluetechnix.com</u>.

and uClinux can be downloaded from: <u>http://blackfin.uClinux.org</u>.

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BLACKFIN Design Service

Based on more than five years of experience with Blackfin, Bluetechnix offers development assistance as well as custom design services and software development.



1 Introduction

The EXT-BF5xx-EXP-TR Board is an extender board that can be plugged on all Blackfin based Development and Evaluation Boards.

1.1 Overview

The EXT-BF5xx-EXP-TR Board includes the following components.

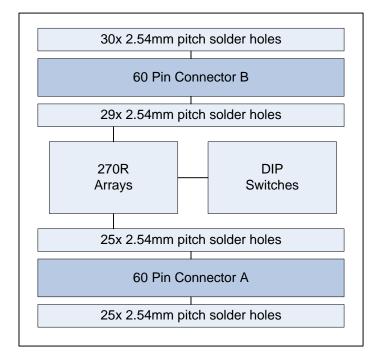


Figure 1-1: Overview of the EXT-BF5xx-EXP-TR Board

- 113 Expansion Holes
- 12 270R Arrays
- 6 DIP Switches



2 Specification

2.1 Schematics

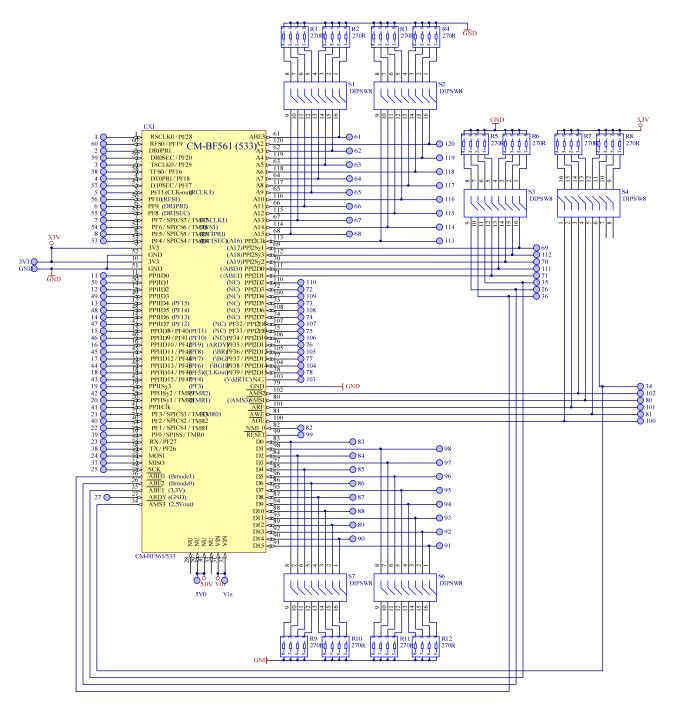
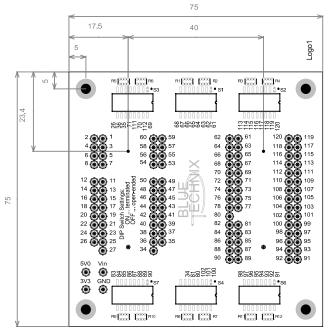


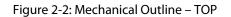
Figure 2-1: Schematics of the EXT-BF5xx-EXP-TR Board

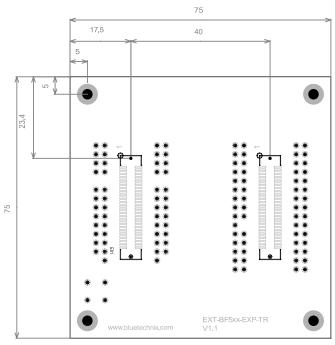


2.2 Mechanical Outline



Dimensions in mm (Millimeter)





Dimensions in mm (Millimeter)

Figure 2-3: Mechanical Outline – BOTTOM



2.3 DIP Switches

Using switches S1, S2, S3, S6 and S7 it is possible to tie the connected lines over a 270 Ohm resistor to ground. The switch S5 can be used to connect all the lines over a 270 Ohm resistor to 3V3.



3 Anomalies

For the latest information regarding anomalies for this product, please consult the product home page:

http://www.bluetechnix.com/



4 Product Changes

1.1 First relea	ise

Table 4-1: Product Changes



5 Document Revision History

Version	Date	Document Revision
1	2010-02-08	First release

Table 5-1: Document Revision History